

2A, 200V-1000V Fast Recovery Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated junction chip
- Ideal for automated placement
- Low power loss, high efficiency
- Fast switching for high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS

PARAMETER	VALUE	UNIT
I_F	2	A
V_{RRM}	200-1000	V
I_{FSM}	50	A
$T_J \text{ MAX}$	150	°C
Package	Thin SMA	
Configuration	Single Die	

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application



Thin SMA



MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.029g (approximately)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	SYMBOL	RS2DALH	RS2GALH	RS2JALH	RS2KALH	RS2MALH	UNIT
Marking code on the device		RS2DAH	RS2GAH	RS2JAH	RS2KAH	RS2MAH	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V
Forward current	I_F	2					A
Surge peak forward current, single half sine-wave superimposed on rated load	$t = 8.3\text{ms}$	I_{FSM} 50					A
	$t = 1.0\text{ms}$	140					A
Junction temperature	T_J	-55 to +150					°C
Storage temperature	T_{STG}	-55 to +150					°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	16	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	73	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	14	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	RS2DALH RS2GALH RS2JALH	I _F = 1A, T _J = 25°C	V _F	0.93	-	V
		I _F = 2A, T _J = 25°C		1.01	1.30	V
		I _F = 1A, T _J = 125°C		0.78	-	V
		I _F = 2A, T _J = 125°C		0.88	1.02	V
	RS2KALH RS2MALH	I _F = 1A, T _J = 25°C		0.98	-	V
		I _F = 2A, T _J = 25°C		1.06	1.30	V
		I _F = 1A, T _J = 125°C		0.83	-	V
		I _F = 2A, T _J = 125°C		0.93	1.05	V
		Reverse current @ rated V _R ⁽²⁾		T _J = 25°C	I _R	-
T _J = 125°C	-			40		µA
Reverse recovery time	RS2DALH RS2GALH	I _F = 0.5A, I _R = 1.0A, I _{rr} = 0.25A	t _{rr}	-	150	ns
	RS2JALH			-	250	ns
	RS2KALH RS2MALH			-	500	ns
Junction capacitance	RS2DALH RS2GALH RS2JALH	1MHz, V _R = 4.0V	C _J	11	-	pF
	RS2KALH RS2MALH			10	-	pF

Notes:

(1) Pulse test with $PW = 0.3\text{ms}$

(2) Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
RS2xALH M3G	Thin SMA	3,500 / 7" reel
RS2xALH M2G	Thin SMA	14,000 / 13" reel

Notes:

(1) "x" defines voltage from 200V(RS2DALH) to 1000V(RS2MALH)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

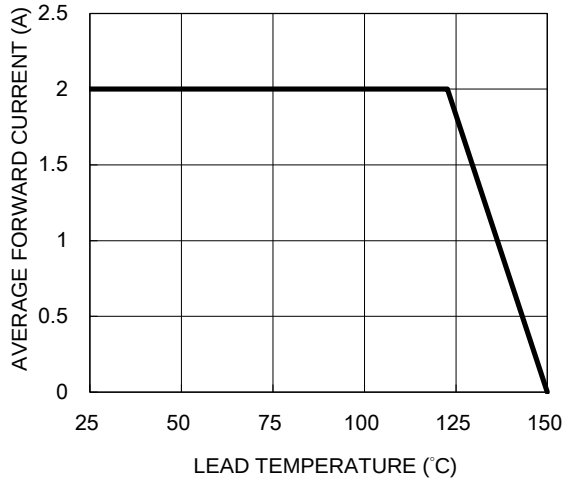


Fig.2 Typical Junction Capacitance

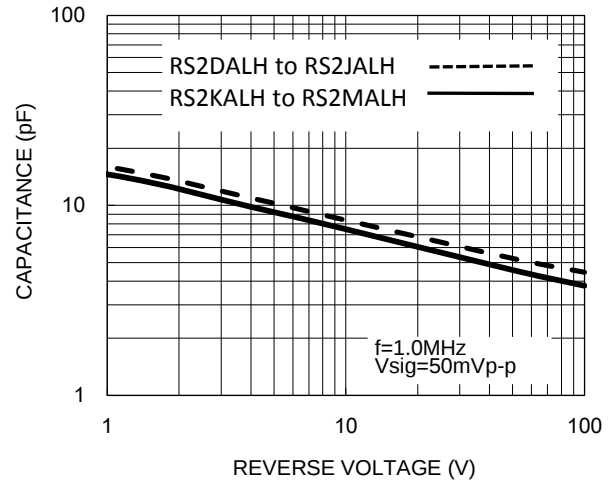


Fig.3 Typical Reverse Characteristics

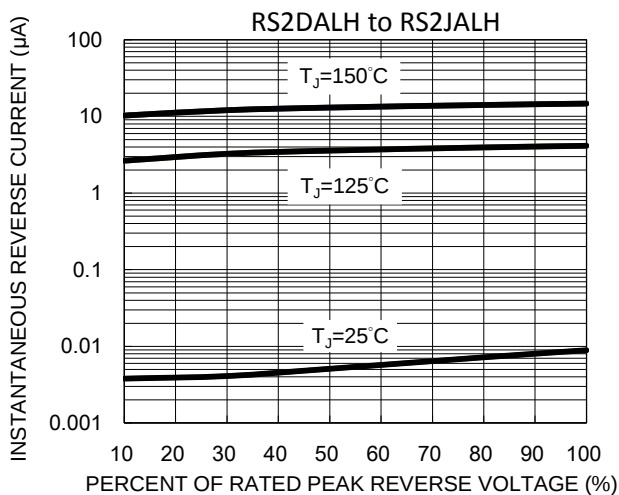


Fig.4 Typical Forward Characteristics

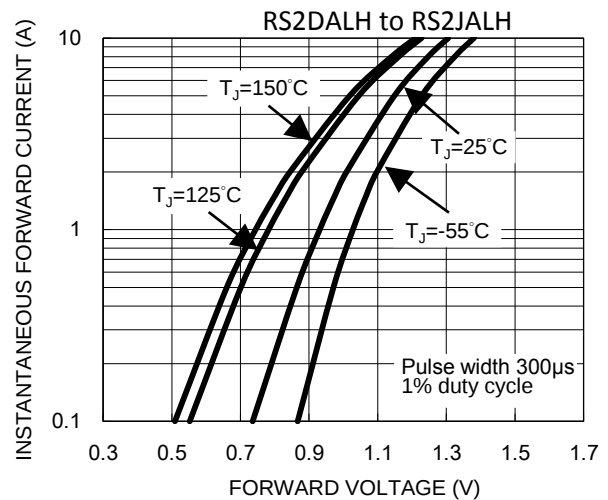


Fig.5 Typical Reverse Characteristics

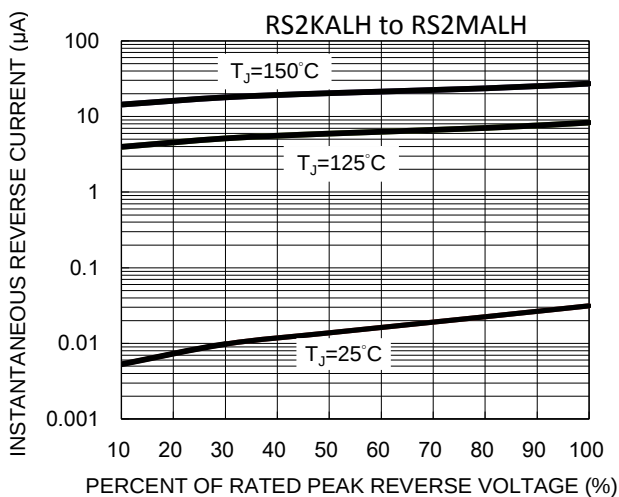
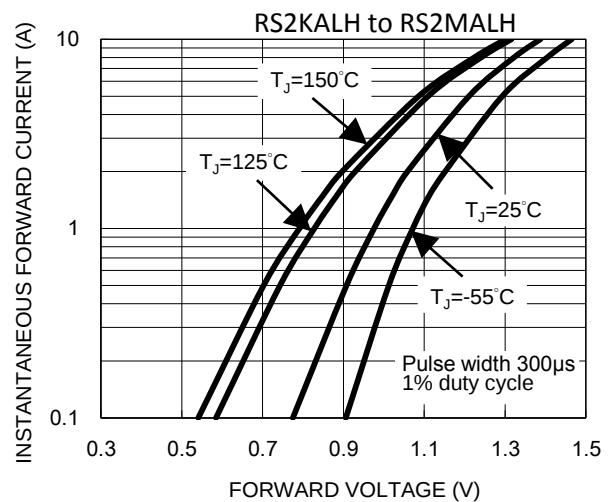


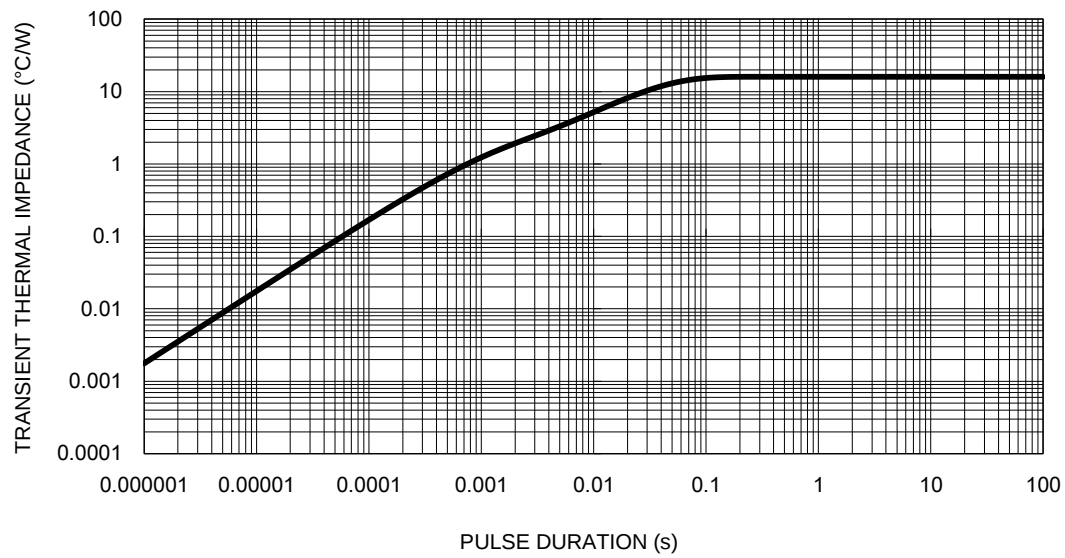
Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

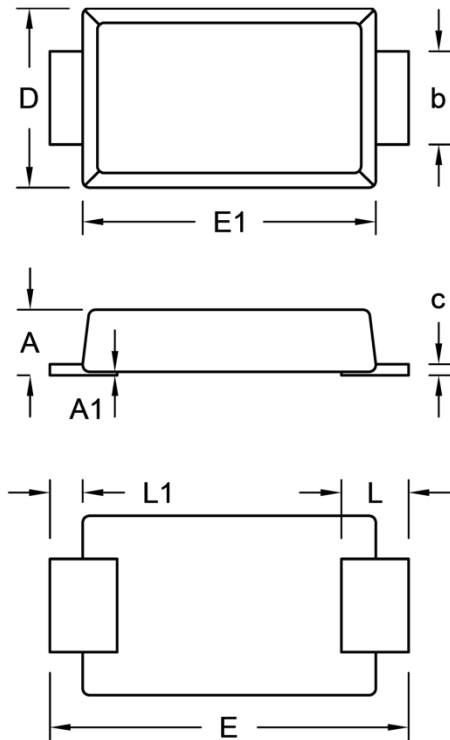
($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.7 Typical Transient Thermal Impedance



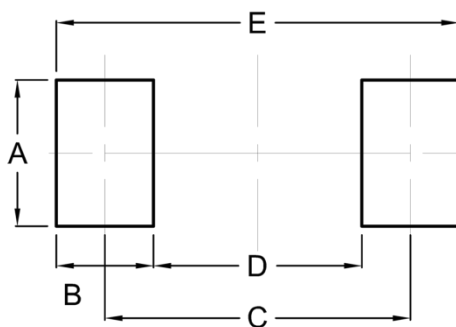
PACKAGE OUTLINE DIMENSIONS

Thin SMA



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.90	1.00	0.035	0.039
A1	0.00	0.10	0.000	0.004
b	1.25	1.45	0.049	0.057
c	0.10	0.22	0.004	0.009
D	2.50	2.70	0.098	0.106
E	5.05	5.35	0.199	0.211
E1	4.15	4.35	0.163	0.171
L	0.75	1.20	0.030	0.047
L1	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.10	0.083
B	1.40	0.055
C	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N = Marking Code
 YW = Date Code
 F = Factory Code

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